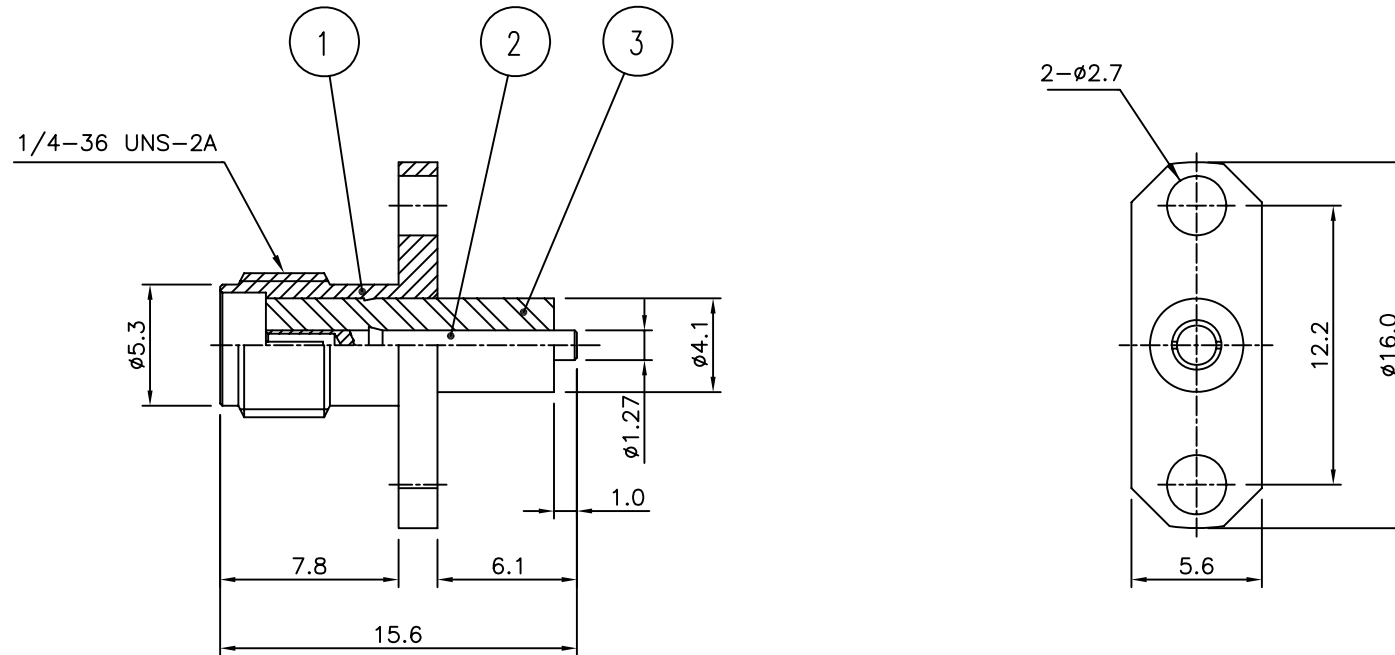


REVISION						
REV	DESCRIPTION			DRAWN	APPR	DATE
IR	Initial Registration			H.J.LEE	I.C.KIM	2015.08.07.
1	절연체 공용화로 인한 코드 변경			S.Y.EUN	I.C.KIM	2020.12.24.



3	INSULATOR	1	TEFLON		DIN02077-N/1 DIN00089-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT02579-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD00347-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2020. 12. 24.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		KJ COMTECH CO.,LTD. TITLE SMA50 SOLDER END JS-2H
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	3/1	A4 DWG NO. CN03464-7/1 REVISION 1 SHEET 1 of 1
		UNIT	mm	